Vishay General Semiconductor

Surface-Mount Low V_F Standard Rectifiers



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SE12DX Anode 1 O K Anode 2 O Cathode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS					
I _{F(AV)}	12 A				
V _{RRM}	400 V, 600 V				
I _{FSM}	165 A				
V_F at I_F = 12 A (T_A = 125 °C)	0.83 V				
T _J max.	175 °C				
Package	SMPD (TO-263AC)				
Circuit configuration	Single				

FEATURES

- Very low profile typical height of 1.7 mm
- Low forward voltage drop
- AEC-Q101 qualified available
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C



TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

MECHANICAL DATA

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER		SE12DLG SE12DLJ		UNIT		
Device marking code		SE12DLG	SE12DLJ			
Maximum repetitive peak reverse voltage		400	600	V		
Maximum DC forward current	I _F ⁽¹⁾	12		A		
Maximum DC forward current	I _F ⁽²⁾	3.7				
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	165		A		
Operating junction and storage temperature range	T _J , T _{STG} ⁽³⁾	T _{STG} ⁽³⁾ -55 to +175		°C		

Notes

⁽¹⁾ Mounted on infinite heatsink

⁽²⁾ Free air, mounted on recommended copper pad area

 $^{(3)}$ The heat generated must be less than the thermal conductivity from junction to ambient dP_D/dT_J < R_{thJA}



RoHS COMPLIANT HALOGEN FREE



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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 6 A	– T _A = 25 °C		0.86	-	v
	I _F = 12 A		V _F (1)	0.93	1	
	I _F = 6 A	– T _A = 125 °C	• • F (.)	0.72	-	
	I _F = 12 A			0.83	0.9	
Reverse current	Rated V _B	$\begin{array}{c} T_{A} = 25 \ ^{\circ}C \\ T_{A} = 125 \ ^{\circ}C \end{array} \qquad \qquad I_{R} \ ^{(2)} \end{array}$	-	5		
	naleu v _R		IR (=/	12	70	μA
Typical reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	300	-	ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	96	-	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25$ °c unless otherwise noted)					
PARAMETER	SYMBOL	SE12DLG SE12DLJ		UNIT	
Typical thermal resistance	R _{0JA} (1)(2)	55		°C/W	
Typical thermal resistance	R _{0JM} ⁽³⁾	1.5			

Notes

⁽¹⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance R_{0JA} - junction to ambient to follow JEDEC[®] 51-2A

⁽³⁾ Mounted on infinite heatsink thermal resistance R_{thJM} - junction to mount to follow JEDEC[®] 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
SE12DLJ-M3/I	0.54	I	2000/reel	13" diameter plastic tape and reel	
SE12DLJHM3/I ⁽¹⁾	0.54	I	2000/reel	13" diameter plastic tape and reel	

Note

⁽¹⁾ AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

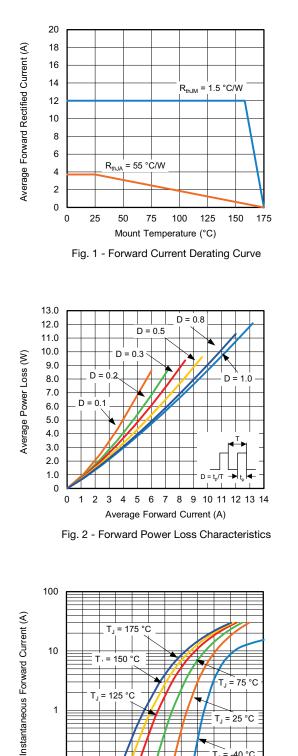




Fig. 3 - Typical Instantaneous Forward Characteristics

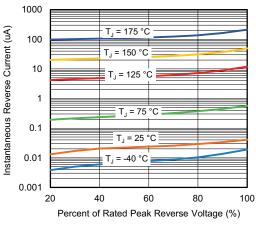


Fig. 4 - Typical Reverse Leakage Characteristics

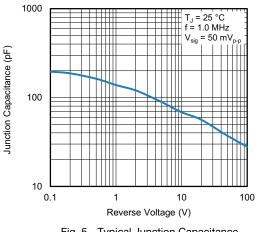
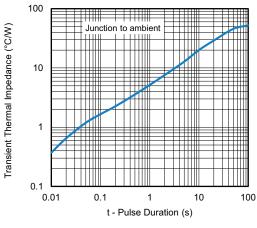
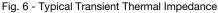


Fig. 5 - Typical Junction Capacitance





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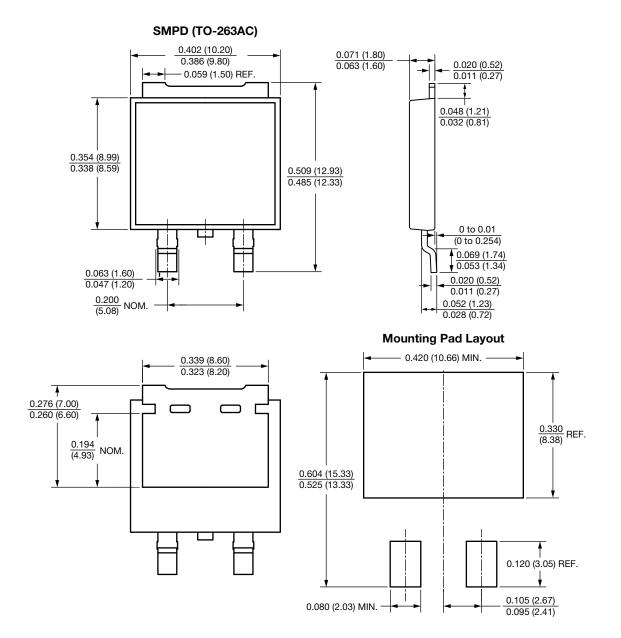
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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